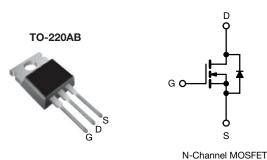
Vishay Siliconix

Power MOSFET



RY	
560	0
V _{GS} = 10 V	0.225
76	
21	
29	
Sing	le
	560 V _{GS} = 10 V

FEATURES

- Low figure-of-merit R_{on} x Q_a
- 100 % avalanche tested
- High peak current capability
- dv/dt ruggedness
- Improved t_{rr}/Q_{rr}
- · Improved gate charge
- · High power dissipations capability
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP18N50C-E3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	500		
Gate-source voltage				± 30	V	
Continuous drain august /T 150 °C) 8	V at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	- I _D	18		
Continuous drain current (T _J = 150 °C) ^a	V _{GS} at 10 V	T _C = 100 °C		11	Α	
Pulsed drain current ^b			I _{DM}	72		
Linear derating factor				1.8	W/°C	
Single pulse avalanche energy c			E _{AS}	361	mJ	
Maximum power dissipation			P _D	223	W	
Reverse diode dv/dt ^d			dv/dt	5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^d	For	10 s		300		

Notes

- a. Drain current limited by maximum junction temperature
- b. Repetitive rating; pulse width limited by maximum junction temperature
- c. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.5 mH, R_g = 25 Ω , I_{AS} = 17 A
- d. $I_{SD} \leq 18$ A, di/dt ≤ 380 A/µs, $V_{DD} \leq V_{DS},\, T_{J} \leq 150$ °C
- e. 1.6 mm from case

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	0.56	G/ VV



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.6	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	=.	-	± 100	nA
Zoro coto voltacio duois ovuront		V _{DS} =	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$		-	25	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 400 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A	-	0.225	0.270	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 50 V, I _D = 10 A	-	6.4	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1 MHz		-	2451	2942	pF
Output capacitance	C _{oss}			-	300	360	
Reverse transfer capacitance	C _{rss}			-	26	32	
Total gate charge	Q_g			-	65	76	
Gate-source charge	Q_{gs}	V _{GS} = 10 V	-	21	-	nC	
Gate-drain charge	Q _{gd}			-	29	-	
Turn-on delay time	t _{d(on)}			-	80	-	
Rise time	t _r	V _{DD} =	250 V, I _D = 18 A,	-	27	-	1
Turn-off delay time	t _{d(off)}	$V_{GS} = 10 \text{ V}, R_g = 7.5 \Omega$		-	32	-	ns ns
Fall time	t _f			-	44	-	
Gate input resistance	R _g	f = 1 MHz, open drain		=.	1.1	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	18	
Pulsed diode forward current	I _{SM}			-	-	72	Α
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 18 A, V _{GS} = 0 V	-	-	1.5	V
Reverse recovery time	t _{rr}	-	* *	-	503	-	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S,$ di/dt = 100 A/ μ s, $V_R = 35 \text{V}$		-	6.7	-	μC
Reverse recovery current	I _{RRM}				30	_	A

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

The information shown here is a preliminary product proposal, not a commercial product datasheet. Vishay Siliconix is not committed to produce this or any similar product. This information should not be used for design purposes, nor construed as an offer to furnish or sell such products.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

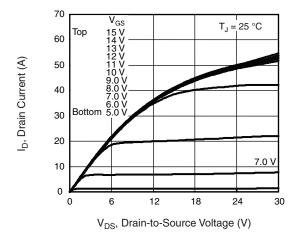


Fig. 1 - Typical Output Characteristics, T_C = 150 °C

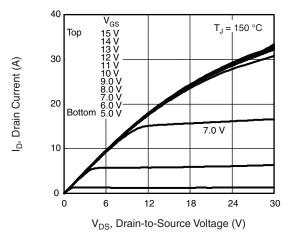


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

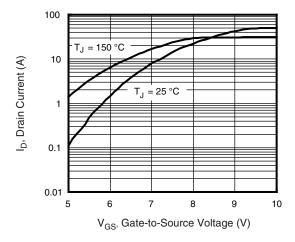


Fig. 3 - Typical Transfer Characteristics

S17-1726-Rev. E, 20-Nov-17

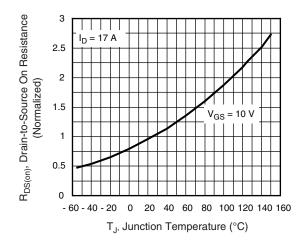


Fig. 4 - Normalized On-Resistance vs. Temperature

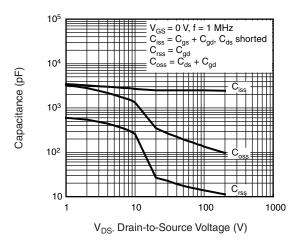


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

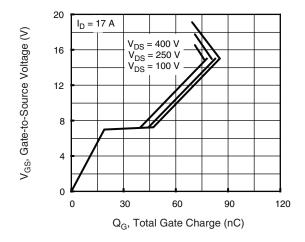
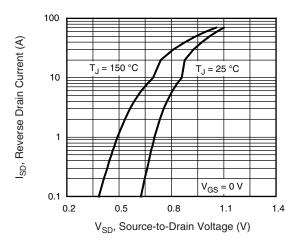


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage







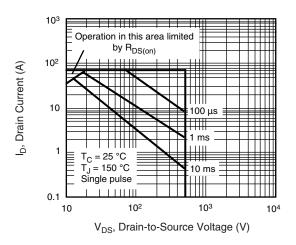


Fig. 8 - Maximum Safe Operating Area

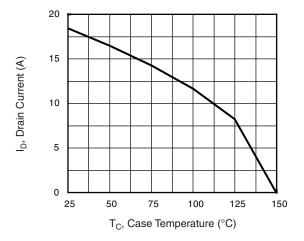


Fig. 9 - Maximum Drain Current vs. Case Temperature

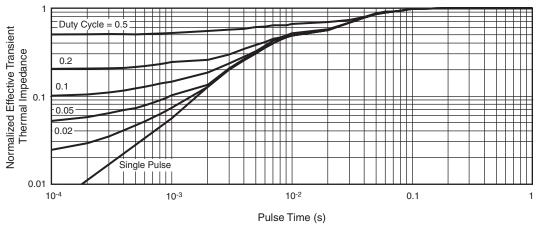


Fig. 10 - Normalized Thermal Transient Impedance, Junction-to-Case



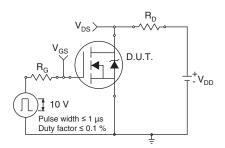


Fig. 11 - Switching Time Test Circuit

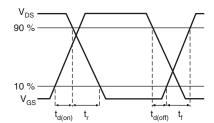


Fig. 12 - Switching Time Waveforms

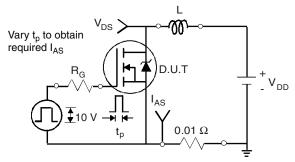


Fig. 13 - Unclamped Inductive Test Circuit

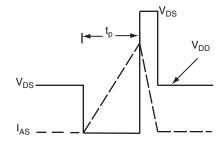


Fig. 14 - Unclamped Inductive Waveforms

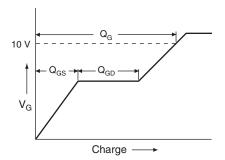


Fig. 15 - Basic Gate Charge Waveform

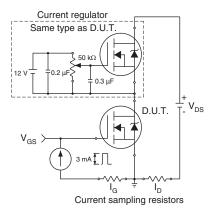
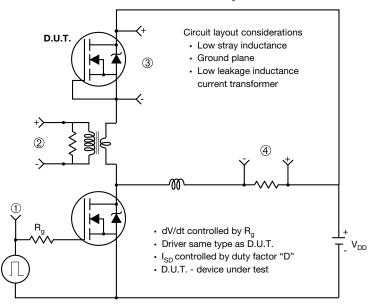


Fig. 16 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



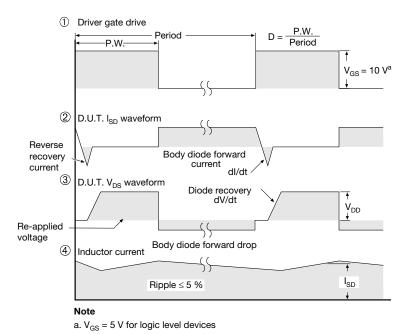
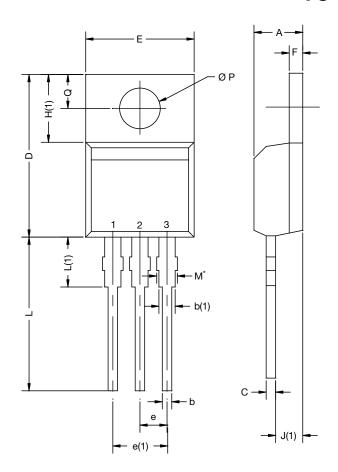


Fig. 17 - For N-Channel

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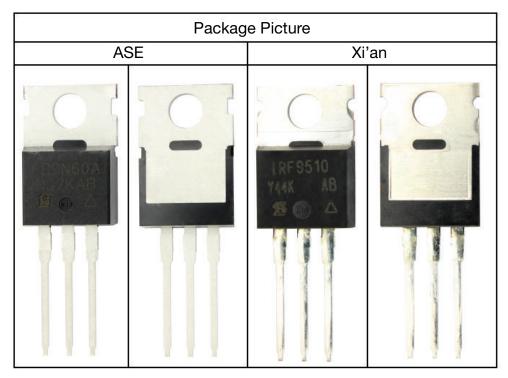
TO-220-1



DIM	MILLIM	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0 DWG: 6031)364-Rev. C,	14-Dec-15			

Note

 M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

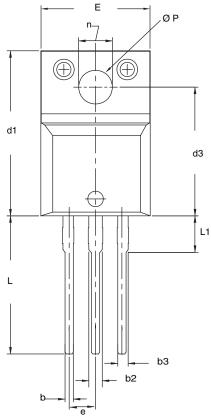


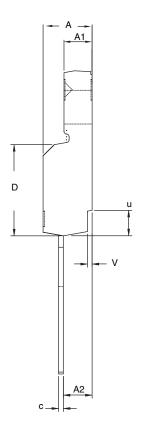
Revison: 14-Dec-15 1 Document Number: 66542



Vishay Siliconix

TO-220 FULLPAK (HIGH VOLTAGE)





DIM.	MILLIN	METERS	INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
С	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
E	10.360	10.630	0.408	0.419
е	2.54	BSC	0.100 BSC	
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
ØP	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
V	0.400	0.500	0.016	0.020

ECN: X09-0126-Rev. B, 26-Oct-09 DWG: 5972

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
- 4. All dimensions include burrs and plating thickness.
- 5. No chipping or package damage.

Document Number: 91359 Revision: 26-Oct-09

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